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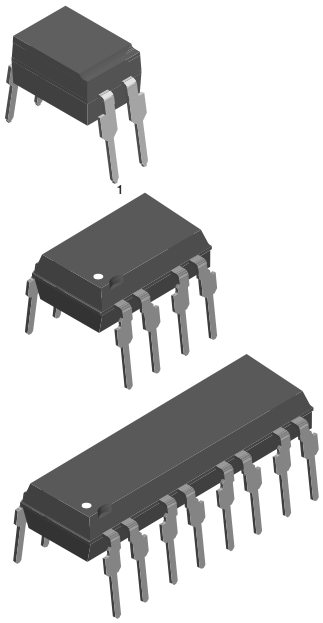
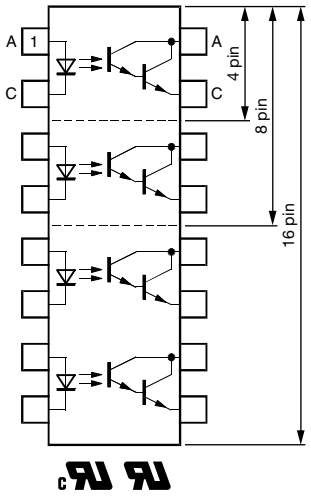
Optocoupler, Photodarlington Output





FEATURES

- Endstackable to 2.54 mm (0.1") spacing
- Isolation test voltage 5300 V_{RMS}
- Low temperature coefficient of CTR
- Wide ambient temperature range
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

Pb-free

e3

RoHS COMPLIANT

APPLICATIONS

- Programmable logic controllers
- Modems
- Answering machines
- General applications

AGENCY APPROVALS

- UL1577, file no. E76222 system code C, double protection
- CSA 22.2 bulletin 5A, double protection
- CQC: GB8898-2001 (K815P only)

DESCRIPTION

In the K815P, K825P, K845P parts, each channel consist of a photodarlington optically coupled to a gallium arsenide infrared-emitting diode in an 4 pin, 8 pin, and 16 pin plastic dual inline package.

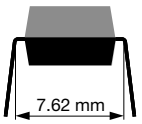
The elements are mounted on one leadframe providing a fixed distance between input and output for highest safety requirements.

ORDERING INFORMATION

K	8	#	5	P

PART NUMBER

DIP-4/DIP-8/DIP-16



AGENCY CERTIFIED/PACKAGE	CTR (%)
UL, cUL	**> 600**
DIP-4 (CQC)	K815P
DIP-8	K825P
DIP-16	K845P

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT				
Reverse voltage		V_R	6	V
Forward current		I_F	60	mA
Forward surge current	$t_p \leq 10$ µs	I_{FSM}	1.5	A
Power dissipation		P_{diss}	100	mW
Junction temperature		T_j	125	°C

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)				
PARAMETER	**TEST CONDITION**	**SYMBOL**	**VALUE**	**UNIT**
OUTPUT				
Collector emitter voltage		V_{CEO}	35	V
Emitter collector voltage		V_{ECO}	7	V
Collector current		I_C	80	mA
Collector peak current	$t_p/T = 0.5$, $t_p \leq 10$ ms	I_{CM}	100	mA
Power dissipation		P_{diss}	150	mW
Junction temperature		T_j	125	°C
COUPLER				
AC isolation test voltage (RMS)	t = 1 min, f = 50 Hz	V_{ISO}	5	kV
Total power dissipation		P_{tot}	250	mW
Operating ambient temperature		T_{amb}	- 40 to + 100	°C
Storage temperature range		T_{stg}	- 55 to + 125	°C
Soldering temperature (1)		T_{sld}	260	°C

Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

(1) Refer to wave profile for soldering conditions for through hole devices.

ELECTRICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
INPUT						
Forward voltage	I_F = 20 mA	V_F		1.2	1.4	V
Reverse current	V_R = 6 V	I_R			10	µA
OUTPUT						
Collector emitter voltage	I_C = 100 µA	V_{CEO}	35			V
Emitter collector voltage	I_E = 100 µA	V_{CEO}	7			V
Collector dark current	V_{CE} = 10 V, I_F = 0 A, E = 0	I_{CEO}			100	nA
COUPLER						
Collector emitter saturation voltage	I_C = 5 mA, I_F = 20 mA	V_{CEsat}			0.1	V
Cut-off frequency	I_F = 10 mA, V_{CE} = 5 V, R_L = 100 Ω	f_c		10		kHz
Coupling capacitance	f = 1 MHz	C_k		0.3		pF

Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

CURRENT TRANSFER RATIO						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
I_C/I_F	I_F = 1 mA, V_{CE} = 2 V	CTR	600	800		%

SWITCHING CHARACTERISTICS						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Rise time	V_{CE} = 2 V, I_C = 10 mA, R_L = 100 Ω (see figure 1)	t_r		300		µs
Turn-off time	V_{CE} = 2 V, I_C = 10 mA, R_L = 100 Ω (see figure 1)	t_{off}		250		µs

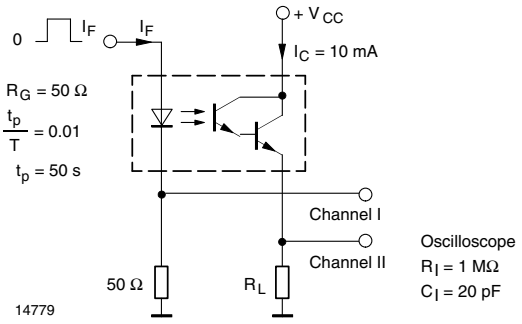


Fig. 1 - Test Circuit, Non-Saturated Operation

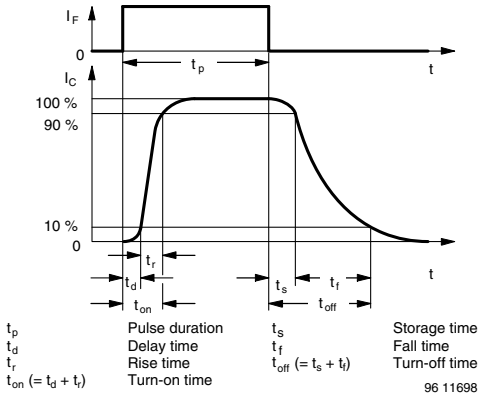


Fig. 2 - Switching Times

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

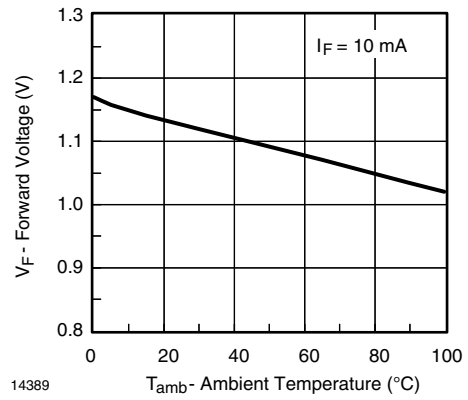


Fig. 3 - Forward Voltage vs. Ambient Temperature

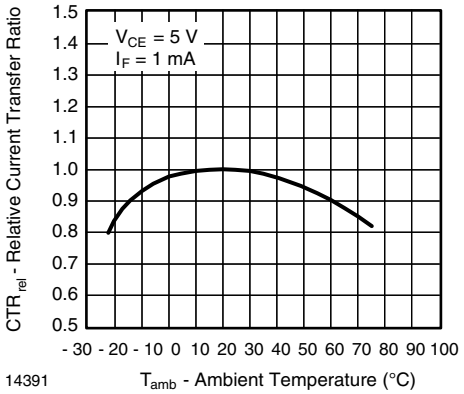


Fig. 5 - Relative Current Transfer Ratio vs. Ambient Temperature

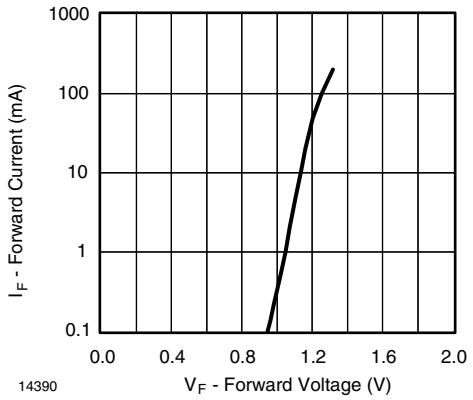


Fig. 4 - Forward Current vs. Forward Voltage

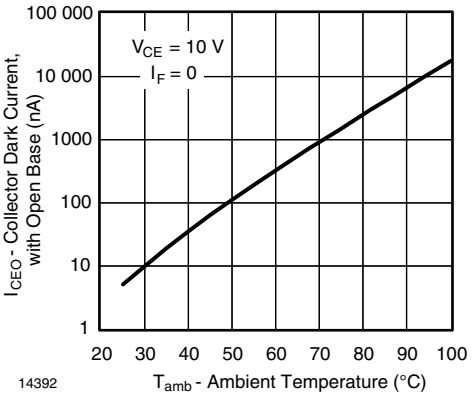


Fig. 6 - Collector Dark Current vs. Ambient Temperature

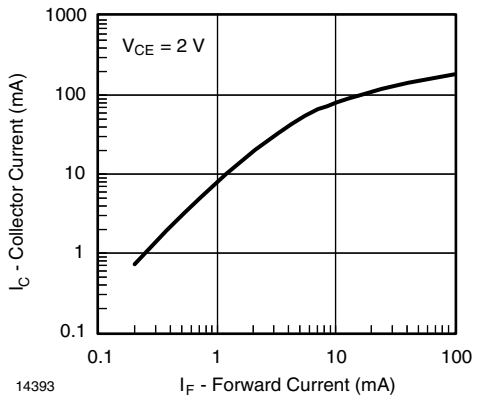


Fig. 7 - Collector Current vs. Forward Current

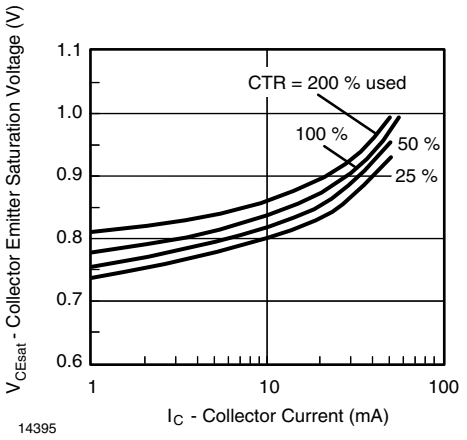


Fig. 9 - Collector Emitter Saturation Voltage vs. Collector Current

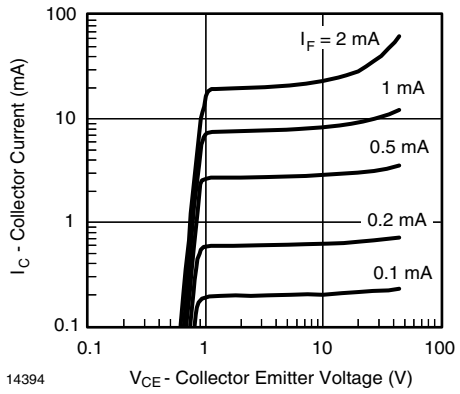


Fig. 8 - Collector Current vs. Collector Emitter Voltage

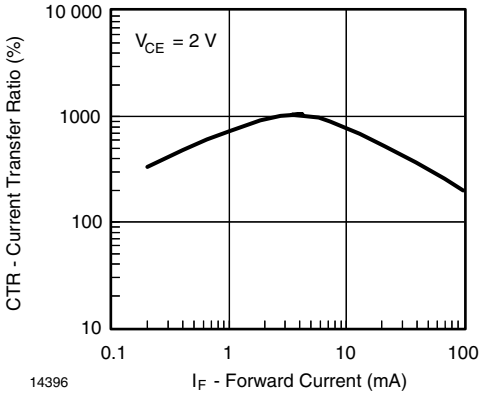
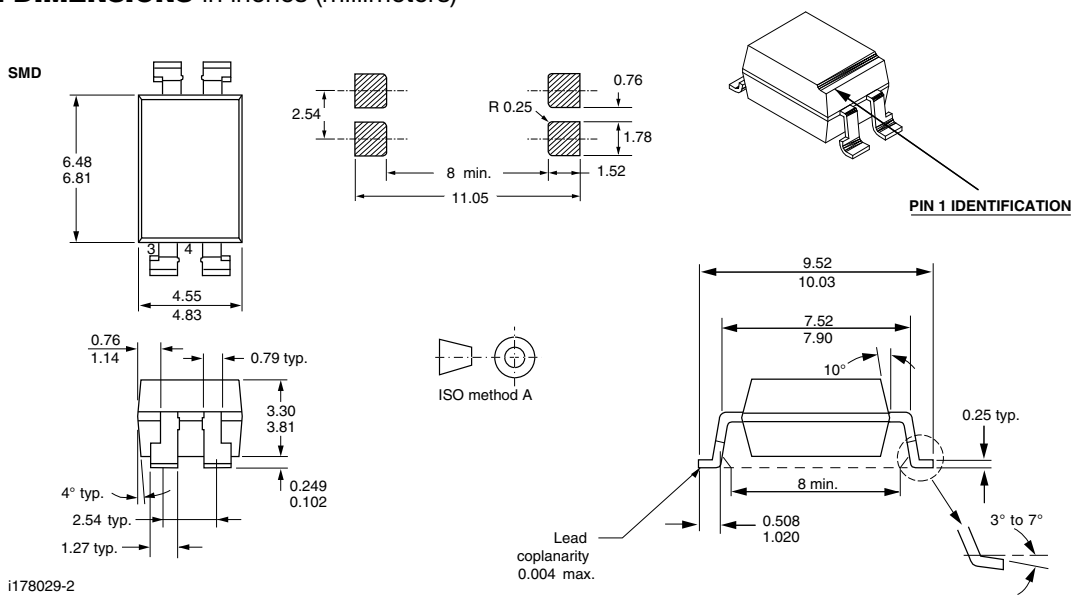
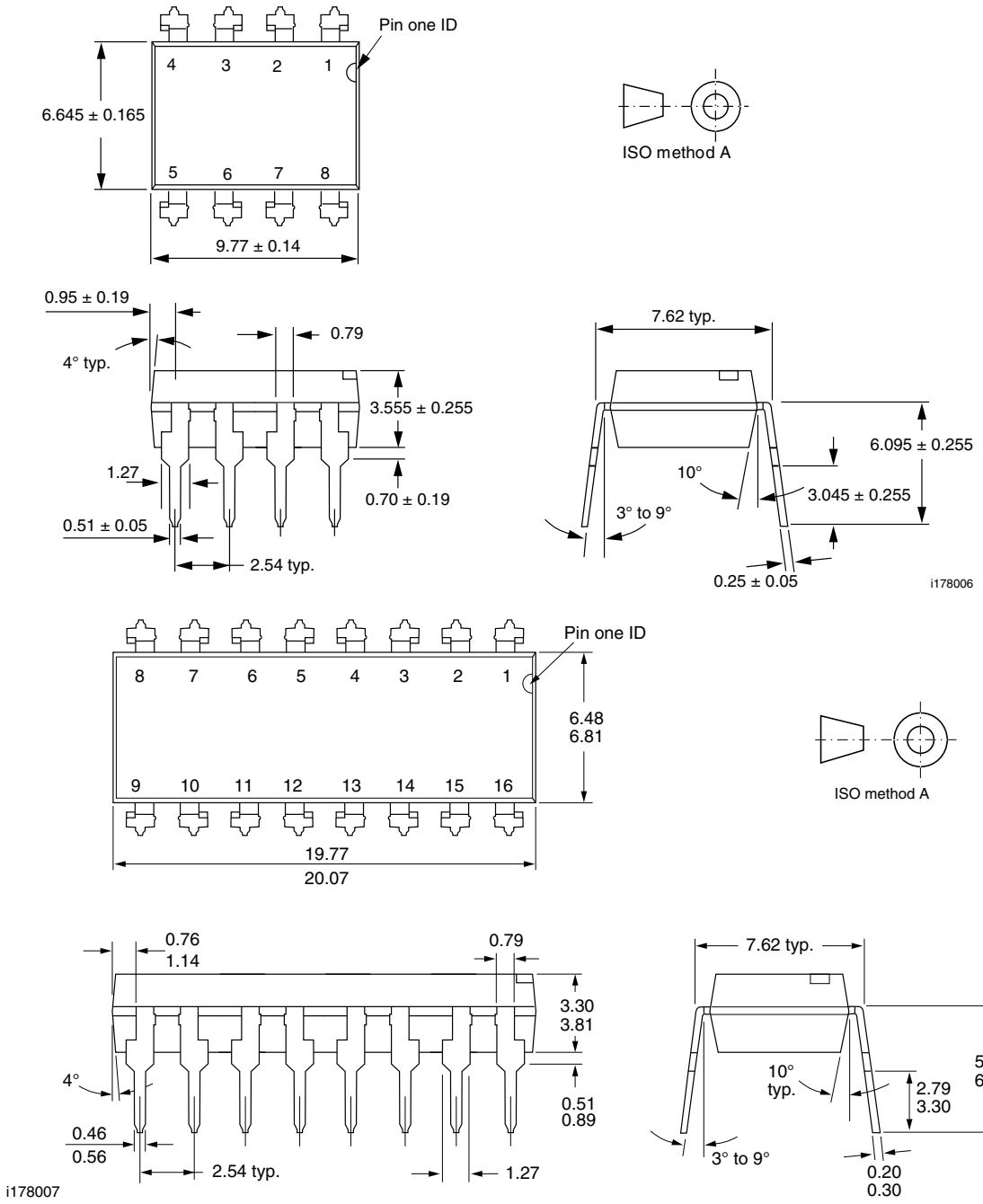


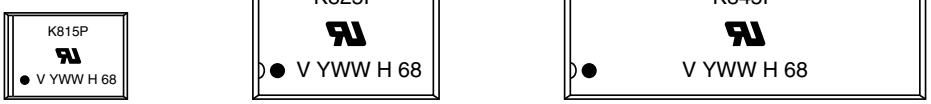
Fig. 10 - Current Transfer Ratio vs. Forward Current

PACKAGE DIMENSIONS in inches (millimeters)





PACKAGE MARKING



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